## Advance Information

# 128K x 36 and 256K x 18 Bit Pipelined BurstRAM Synchronous Fast Static RAM

The MCM63P737K and MCM63P819K are 4M—bit synchronous fast static RAMs designed to provide a burstable, high performance, secondary cache. The MCM63P737K (organized as 128K words by 36 bits) and the MCM63P819K (organized as 256K words by 18 bits) integrate input registers, an output register, a 2—bit address counter, and high speed SRAM onto a single monolithic circuit for reduced parts count in cache data RAM applications. Synchronous design allows precise cycle control with the use of an external clock (K).

Addresses (SA), data inputs (DQx), and all control signals except output enable  $(\overline{G})$ , sleep mode (ZZ), and linear burst order  $(\overline{LBO})$  are clock (K) controlled through positive–edge–triggered noninverting registers.

Bursts can be initiated with either  $\overline{\text{ADSP}}$  or  $\overline{\text{ADSC}}$  input pins. Subsequent burst addresses can be generated internally by the MCM63P737K and MCM63P819K (burst sequence operates in linear or interleaved mode dependent upon the state of  $\overline{\text{LBO}}$ ) and controlled by the burst address advance  $(\overline{\text{ADV}})$  input pin.

Write cycles are internally self–timed and are initiated by the rising edge of the clock (K) input. This feature eliminates complex off–chip write pulse generation and provides increased timing flexibility for incoming signals.

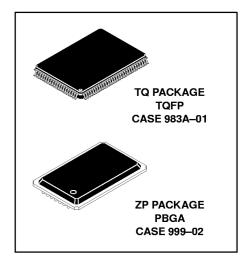
Synchronous byte write  $(\overline{SBx})$ , synchronous global write  $(\overline{SGW})$ , and synchronous write enable  $(\overline{SW})$  are provided to allow writes to either individual bytes or to all bytes. The bytes are designated as "a", "b", etc.  $\overline{SBa}$  controls DQa,  $\overline{SBb}$  controls DQb, etc. Individual bytes are written if the selected byte writes  $\overline{SBx}$  are asserted with  $\overline{SW}$ . All bytes are written if either  $\overline{SGW}$  is asserted or if all  $\overline{SBx}$  and  $\overline{SW}$  are asserted.

For read cycles, pipelined SRAMs output data is temporarily stored by an edge-triggered output register and then released to the output buffers at the next rising edge of clock (K).

The MCM63P737K and MCM63P819K operate from a 3.3 V core power supply and all outputs operate on a 2.5 V or 3.3 V power supply. All inputs and outputs are JEDEC standard JESD8–5 compatible.

- MCM63P737K/MCM63P819K-166 = 3.5 ns Access/6 ns Cycle (166 MHz)
   MCM63P737K/MCM63P819K-150 = 3.8 ns Access/6.7 ns Cycle (150 MHz)
   MCM63P737K/MCM63P819K-133 = 4 ns Access/7.5 ns Cycle (133 MHz)
- 3.3 V +10%, -5% Core Power Supply, 2.5 V or 3.3 V I/O Supply
- ADSP, ADSC, and ADV Burst Control Pins
- Selectable Burst Sequencing Order (Linear/Interleaved)
- Single–Cycle Deselect Timing
- Internally Self-Timed Write Cycle
- Byte Write and Global Write Control
- Sleep Mode (ZZ)
- JEDEC Standard 100-Pin TQFP and 119-Pin PBGA Packages

# MCM63P737K MCM63P819K

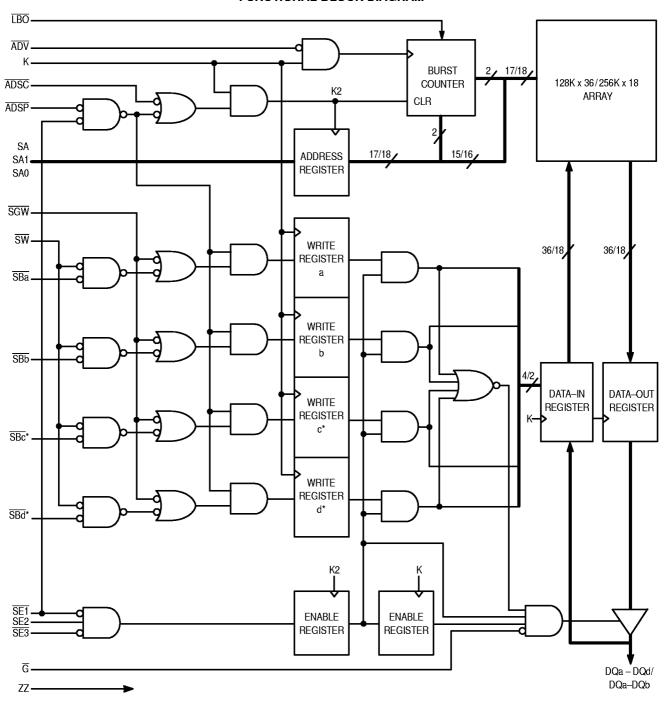


This document contains information on a new product. Specifications and information herein are subject to change without notice.

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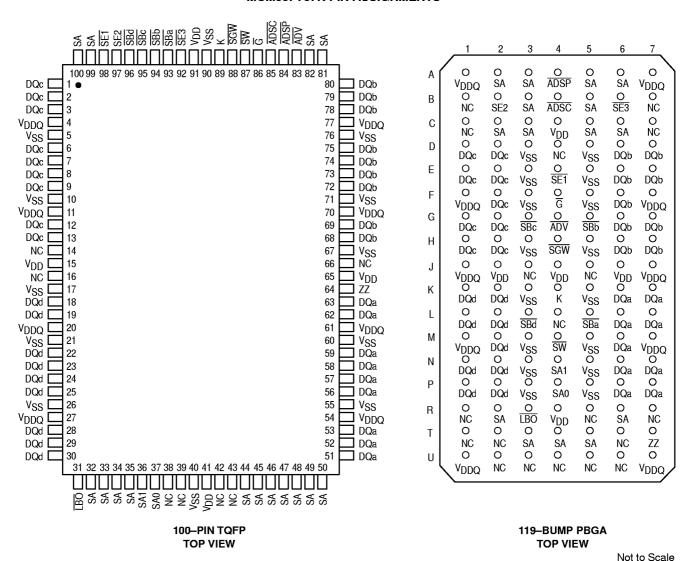


## **FUNCTIONAL BLOCK DIAGRAM**



<sup>\*</sup> Valid only for MCM63P737K.

#### MCM63P737K PIN ASSIGNMENTS



MOTOROLA FAST SRAM

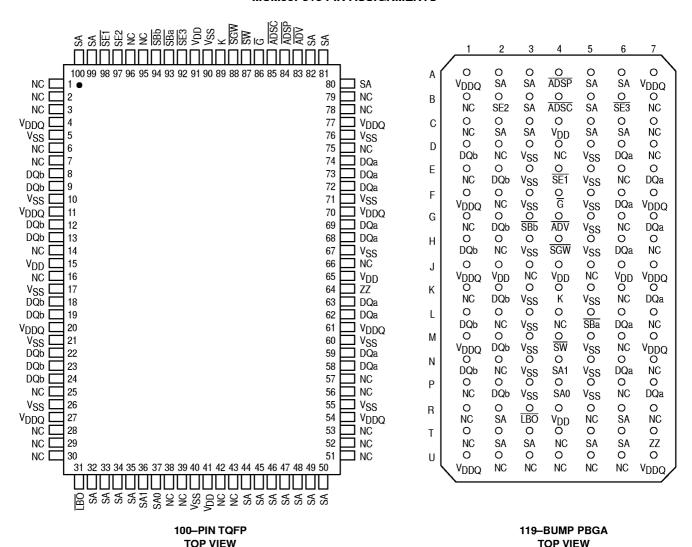
## MCM63P737K TQFP PIN DESCRIPTIONS

| Pin Locations                                                                                                                                                 | Symbol           | Туре   | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------|--------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 85                                                                                                                                                            | ADSC             | Input  | Synchronous Address Status Controller: Active low, interrupts any ongoing burst and latches a new external address. Used to initiate a READ, WRITE, or chip deselect.                                                                                                                                                                                                                                                                                                                                                   |
| 84                                                                                                                                                            | ADSP             | Input  | Synchronous Address Status Processor: Active low, interrupts any ongoing burst and latches a new external address. Used to initiate a new READ, WRITE, or chip deselect (exception — chip deselect does not occur when ADSP is asserted and SE1 is high).                                                                                                                                                                                                                                                               |
| 83                                                                                                                                                            | ADV              | Input  | Synchronous Address Advance: Increments address count in accordance with counter type selected (linear/interleaved).                                                                                                                                                                                                                                                                                                                                                                                                    |
| (a) 51, 52, 53, 56, 57, 58, 59, 62, 63<br>(b) 68, 69, 72, 73, 74, 75, 78, 79, 80<br>(c) 1, 2, 3, 6, 7, 8, 9, 12, 13<br>(d) 18, 19, 22, 23, 24, 25, 28, 29, 30 | DQx              | I/O    | Synchronous Data I/O: "x" refers to the byte being read or written (byte a, b, c, d).                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| 86                                                                                                                                                            | G                | Input  | Asynchronous Output Enable Input: Low — enables output buffers (DQx pins). High — DQx pins are high impedance.                                                                                                                                                                                                                                                                                                                                                                                                          |
| 89                                                                                                                                                            | К                | Input  | Clock: This signal registers the address, data in, and all control signals except $\overline{G}$ , $\overline{LBO}$ , and $ZZ$ .                                                                                                                                                                                                                                                                                                                                                                                        |
| 31                                                                                                                                                            | LBO              | Input  | Linear Burst Order Input: This pin must remain in steady state (this signal not registered or latched). It must be tied high or low.  Low — linear burst counter.  High — interleaved burst counter.                                                                                                                                                                                                                                                                                                                    |
| 32, 33, 34, 35, 44, 45, 46, 47, 48, 49, 50,<br>81, 82, 99, 100                                                                                                | SA               | Input  | Synchronous Address Inputs: These inputs are registered and must meet setup and hold times.                                                                                                                                                                                                                                                                                                                                                                                                                             |
| 36, 37                                                                                                                                                        | SA1, SA0         | Input  | Synchronous Address Inputs: These pins must be wired to the two LSBs of the address bus for proper burst operation. These inputs are registered and must meet setup and hold times.                                                                                                                                                                                                                                                                                                                                     |
| 93, 94, 95, 96<br>(a) (b) (c) (d)                                                                                                                             | SBx              | Input  | Synchronous Byte Write Inputs: "x" refers to the byte being written (byte a, b, c, d). SGW overrides SBx.                                                                                                                                                                                                                                                                                                                                                                                                               |
| 98                                                                                                                                                            | SE1              | Input  | Synchronous Chip Enable: Active low to enable chip.  Negated high — blocks $\overline{\text{ADSP}}$ or deselects chip when $\overline{\text{ADSC}}$ is asserted.                                                                                                                                                                                                                                                                                                                                                        |
| 97                                                                                                                                                            | SE2              | Input  | Synchronous Chip Enable: Active high for depth expansion.                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| 92                                                                                                                                                            | SE3              | Input  | Synchronous Chip Enable: Active low for depth expansion.                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| 88                                                                                                                                                            | SGW              | Input  | Synchronous Global Write: This signal writes all bytes regardless of the status of the $\overline{SBx}$ and $\overline{SW}$ signals. If only byte write signals $\overline{SBx}$ are being used, tie this pin high.                                                                                                                                                                                                                                                                                                     |
| 87                                                                                                                                                            | SW               | Input  | Synchronous Write: This signal writes only those bytes that have been selected using the byte write $\overline{SBx}$ pins. If only byte write signals $\overline{SBx}$ are being used, tie this pin low.                                                                                                                                                                                                                                                                                                                |
| 64                                                                                                                                                            | ZZ               | Input  | Sleep Mode: This active high asynchronous signal places the RAM into the lowest power mode. The ZZ pin disables the RAMs internal clock when placed in this mode. When ZZ is negated, the RAM remains in low power mode until it is commanded to READ or WRITE. Data integrity is maintained upon returning to normal operation. NOTE: An internal pull–down is included for compatibility with SRAM devices that do not support sleep mode. A 100% pin compatibility can be achieved if ZZ is left open or pulled low. |
| 15, 41, 65, 91                                                                                                                                                | V <sub>DD</sub>  | Supply | Core Power Supply.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| 4, 11, 20, 27, 54, 61, 70, 77                                                                                                                                 | V <sub>DDQ</sub> | Supply | I/O Power Supply.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| 5, 10, 17, 21, 26, 40, 55, 60, 67, 71,<br>76, 90                                                                                                              | V <sub>SS</sub>  | Supply | Ground.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| 14, 16, 38, 39, 42, 43, 66                                                                                                                                    | NC               |        | No Connection: There is no connection to the chip.                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |

## MCM63P737K PBGA PIN DESCRIPTIONS

| Pin Locations                                                                                                                                                        | Symbol           | Туре   | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|----------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------|--------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 4B                                                                                                                                                                   | ADSC             | Input  | Synchronous Address Status Controller: Active low, interrupts any ongoing burst and latches a new external address. Used to initiate a READ, WRITE, or chip deselect.                                                                                                                                                                                                                                                                                                                                                   |
| 4A                                                                                                                                                                   | ADSP             | Input  | Synchronous Address Status Processor: Active low, interrupts any ongoing burst and latches a new external address. Used to initiate a new READ, WRITE, or chip deselect (exception — chip deselect does not occur when $\overline{\text{ADSP}}$ is asserted and $\overline{\text{SE1}}$ is high).                                                                                                                                                                                                                       |
| 4G                                                                                                                                                                   | ADV              | Input  | Synchronous Address Advance: Increments address count in accordance with counter type selected (linear/interleaved).                                                                                                                                                                                                                                                                                                                                                                                                    |
| (a) 6K, 7K, 6L, 7L, 6M, 6N, 7N, 6P, 7P<br>(b) 6D, 7D, 6E, 7E, 6F, 6G, 7G, 6H, 7H<br>(c) 1D, 2D, 1E, 2E, 2F, 1G, 2G, 1H, 2H<br>(d) 1K, 2K, 1L, 2L, 2M, 1N, 2N, 1P, 2P | DQx              | I/O    | Synchronous Data I/O: "x" refers to the byte being read or written (byte a, b, c, d).                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| 4F                                                                                                                                                                   | G                | Input  | Asynchronous Output Enable Input: Low — enables output buffers (DQx pins). High — DQx pins are high impedance.                                                                                                                                                                                                                                                                                                                                                                                                          |
| 4K                                                                                                                                                                   | К                | Input  | Clock: This signal registers the address, data in, and all control signals except $\overline{G}$ , $\overline{LBO}$ , and $ZZ$ .                                                                                                                                                                                                                                                                                                                                                                                        |
| 3R                                                                                                                                                                   | LBO              | Input  | Linear Burst Order Input: This pin must remain in steady state (this signal not registered or latched). It must be tied high or low.  Low — linear burst counter.  High — interleaved burst counter.                                                                                                                                                                                                                                                                                                                    |
| 2A, 3A, 5A, 6A, 3B, 5B, 2C, 3C, 5C, 6C, 2R, 6R, 3T, 4T, 5T                                                                                                           | SA               | Input  | Synchronous Address Inputs: These inputs are registered and must meet setup and hold times.                                                                                                                                                                                                                                                                                                                                                                                                                             |
| 4N, 4P                                                                                                                                                               | SA1, SA0         | Input  | Synchronous Address Inputs: These pins must be wired to the two LSBs of the address bus for proper burst operation. These inputs are registered and must meet setup and hold times.                                                                                                                                                                                                                                                                                                                                     |
| 5L, 5G, 3G, 3L<br>(a) (b) (c) (d)                                                                                                                                    | SBx              | Input  | Synchronous Byte Write Inputs: "x" refers to the byte being written (byte a, b, c, d). SGW overrides SBx.                                                                                                                                                                                                                                                                                                                                                                                                               |
| 4E                                                                                                                                                                   | SE1              | Input  | Synchronous Chip Enable: Active low to enable chip.  Negated high — blocks ADSP or deselects chip when ADSC is asserted.                                                                                                                                                                                                                                                                                                                                                                                                |
| 2B                                                                                                                                                                   | SE2              | Input  | Synchronous Chip Enable: Active high for depth expansion.                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| 6B                                                                                                                                                                   | SE3              | Input  | Synchronous Chip Enable: Active low for depth expansion.                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| 4H                                                                                                                                                                   | SGW              | Input  | Synchronous Global Write: This signal writes all bytes regardless of the status of the $\overline{SBx}$ and $\overline{SW}$ signals. If only byte write signals $\overline{SBx}$ are being used, tie this pin high.                                                                                                                                                                                                                                                                                                     |
| 4M                                                                                                                                                                   | SW               | Input  | Synchronous Write: This signal writes only those bytes that have been selected using the byte write \$\overline{SBx}\$ pins. If only byte write signals \$\overline{SBx}\$ are being used, tie this pin low.                                                                                                                                                                                                                                                                                                            |
| 7T                                                                                                                                                                   | ZZ               | Input  | Sleep Mode: This active high asynchronous signal places the RAM into the lowest power mode. The ZZ pin disables the RAMs internal clock when placed in this mode. When ZZ is negated, the RAM remains in low power mode until it is commanded to READ or WRITE. Data integrity is maintained upon returning to normal operation. NOTE: An internal pull–down is included for compatibility with SRAM devices that do not support sleep mode. A 100% pin compatibility can be achieved if ZZ is left open or pulled low. |
| 4C, 2J, 4J, 6J, 4R                                                                                                                                                   | V <sub>DD</sub>  | Supply | Core Power Supply.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| 1A, 7A, 1F, 7F, 1J, 7J, 1M, 7M, 1U, 7U                                                                                                                               | V <sub>DDQ</sub> | Supply | I/O Power Supply.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| 3D, 5D, 3E, 5E, 3F, 5F, 3H, 5H, 3K, 5K, 3M, 5M, 3N, 5N, 3P, 5P                                                                                                       | V <sub>SS</sub>  | Supply | Ground.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| 1B, 7B, 1C, 7C, 4D, 3J, 5J, 4L, 1R, 5R, 7R, 1T, 2T, 6T, 2U, 3U, 4U, 5U, 6U                                                                                           | NC               | _      | No Connection: There is no connection to the chip.                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |

#### MCM63P818 PIN ASSIGNMENTS



Not to Scale

## MCM63P819K TQFP PIN DESCRIPTIONS

| Pin Locations                                                                                     | Symbol           | Туре   | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|---------------------------------------------------------------------------------------------------|------------------|--------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 85                                                                                                | ADSC             | Input  | Synchronous Address Status Controller: Active low, interrupts any ongoing burst and latches a new external address. Used to initiate a READ, WRITE, or chip deselect.                                                                                                                                                                                                                                                                                                                                                   |
| 84                                                                                                | ADSP             | Input  | Synchronous Address Status Processor: Active low, interrupts any ongoing burst and latches a new external address. Used to initiate a new READ, WRITE, or chip deselect (exception — chip deselect does not occur when $\overline{ADSP}$ is asserted and $\overline{SE1}$ is high).                                                                                                                                                                                                                                     |
| 83                                                                                                | ADV              | Input  | Synchronous Address Advance: Increments address count in accordance with counter type selected (linear/interleaved).                                                                                                                                                                                                                                                                                                                                                                                                    |
| (a) 58, 59, 62, 63, 68, 69, 72, 73, 74<br>(b) 8, 9, 12, 13, 18, 19, 22, 23, 24                    | DQx              | I/O    | Synchronous Data I/O: "x" refers to the byte being read or written (byte a, b).                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| 86                                                                                                | G                | Input  | Asynchronous Output Enable Input: Low — enables output buffers (DQx pins). High — DQx pins are high impedance.                                                                                                                                                                                                                                                                                                                                                                                                          |
| 89                                                                                                | К                | Input  | Clock: This signal registers the address, data in, and all control signals except $\overline{G}$ , $\overline{LBO}$ , and $ZZ$ .                                                                                                                                                                                                                                                                                                                                                                                        |
| 31                                                                                                | LBO              | Input  | Linear Burst Order Input: This pin must remain in steady state (this signal not registered or latched). It must be tied high or low.  Low — linear burst counter.  High — interleaved burst counter.                                                                                                                                                                                                                                                                                                                    |
| 32, 33, 34, 35, 44, 45, 46, 47, 48, 49, 50,<br>80, 81, 82, 99, 100                                | SA               | Input  | Synchronous Address Inputs: These inputs are registered and must meet setup and hold times.                                                                                                                                                                                                                                                                                                                                                                                                                             |
| 36, 37                                                                                            | SA1, SA0         | Input  | Synchronous Address Inputs: These pins must be wired to the two LSBs of the address bus for proper burst operation. These inputs are registered and must meet setup and hold times.                                                                                                                                                                                                                                                                                                                                     |
| 93, 94<br>(a) (b)                                                                                 | SBx              | Input  | Synchronous Byte Write Inputs: "x" refers to the byte being written (byte a, b). SGW overrides SBx.                                                                                                                                                                                                                                                                                                                                                                                                                     |
| 98                                                                                                | SE1              | Input  | Synchronous Chip Enable: Active low to enable chip.  Negated high — blocks $\overline{\text{ADSP}}$ or deselects chip when $\overline{\text{ADSC}}$ is asserted.                                                                                                                                                                                                                                                                                                                                                        |
| 97                                                                                                | SE2              | Input  | Synchronous Chip Enable: Active high for depth expansion.                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| 92                                                                                                | SE3              | Input  | Synchronous Chip Enable: Active low for depth expansion.                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| 88                                                                                                | SGW              | Input  | Synchronous Global Write: This signal writes all bytes regardless of the status of the $\overline{SBx}$ and $\overline{SW}$ signals. If only byte write signals $\overline{SBx}$ are being used, tie this pin high.                                                                                                                                                                                                                                                                                                     |
| 87                                                                                                | SW               | Input  | Synchronous Write: This signal writes only those bytes that have been selected using the byte write $\overline{SBx}$ pins. If only byte write signals $\overline{SBx}$ are being used, tie this pin low.                                                                                                                                                                                                                                                                                                                |
| 64                                                                                                | ZZ               | Input  | Sleep Mode: This active high asynchronous signal places the RAM into the lowest power mode. The ZZ pin disables the RAMs internal clock when placed in this mode. When ZZ is negated, the RAM remains in low power mode until it is commanded to READ or WRITE. Data integrity is maintained upon returning to normal operation. NOTE: An internal pull–down is included for compatibility with SRAM devices that do not support sleep mode. A 100% pin compatibility can be achieved if ZZ is left open or pulled low. |
| 15, 41, 65, 91                                                                                    | V <sub>DD</sub>  | Supply | Core Power Supply.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| 4, 11, 20, 27, 54, 61, 70, 77                                                                     | V <sub>DDQ</sub> | Supply | I/O Power Supply.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| 5, 10, 17, 21, 26, 40, 55, 60, 67, 71, 76, 90                                                     | V <sub>SS</sub>  | Supply | Ground.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| 1, 2, 3, 6, 7, 14, 16, 25, 28, 29, 30, 38, 39, 42, 43, 51, 52, 53, 56, 57, 66, 75, 78, 79, 95, 96 | NC               | _      | No Connection: There is no connection to the chip.                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |

## MCM63P819K PBGA PIN DESCRIPTIONS

| Pin Locations                                                                                                                                  | Symbol           | Туре   | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|------------------------------------------------------------------------------------------------------------------------------------------------|------------------|--------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 4B                                                                                                                                             | ADSC             | Input  | Synchronous Address Status Controller: Active low, interrupts any ongoing burst and latches a new external address. Used to initiate a READ, WRITE, or chip deselect.                                                                                                                                                                                                                                                                                                                                                   |
| 4A                                                                                                                                             | ADSP             | Input  | Synchronous Address Status Processor: Active low, interrupts any ongoing burst and latches a new external address. Used to initiate a new READ, WRITE, or chip deselect (exception — chip deselect does not occur when $\overline{\text{ADSP}}$ is asserted and $\overline{\text{SE1}}$ is high).                                                                                                                                                                                                                       |
| 4G                                                                                                                                             | ADV              | Input  | Synchronous Address Advance: Increments address count in accordance with counter type selected (linear/interleaved).                                                                                                                                                                                                                                                                                                                                                                                                    |
| (a) 6D, 7E, 6F, 7G, 6H, 7K, 6L, 6N, 7P<br>(b) 1D, 2E, 2G, 1H, 2K, 1L, 2M, 1N, 2P                                                               | DQx              | I/O    | Synchronous Data I/O: "x" refers to the byte being read or written (byte a, b).                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| 4F                                                                                                                                             | G                | Input  | Asynchronous Output Enable Input: Low — enables output buffers (DQx pins). High — DQx pins are high impedance.                                                                                                                                                                                                                                                                                                                                                                                                          |
| 4K                                                                                                                                             | К                | Input  | Clock: This signal registers the address, data in, and all control signals except $\overline{G}$ , $\overline{LBO}$ , and $ZZ$ .                                                                                                                                                                                                                                                                                                                                                                                        |
| 3R                                                                                                                                             | LBO              | Input  | Linear Burst Order Input: This pin must remain in steady state (this signal not registered or latched). It must be tied high or low.  Low — linear burst counter.  High — interleaved burst counter.                                                                                                                                                                                                                                                                                                                    |
| 2A, 3A, 5A, 6A, 3B, 5B, 2C, 3C, 5C, 6C, 2R, 6R, 2T, 3T, 5T, 6T                                                                                 | SA               | Input  | Synchronous Address Inputs: These inputs are registered and must meet setup and hold times.                                                                                                                                                                                                                                                                                                                                                                                                                             |
| 4N, 4P                                                                                                                                         | SA1, SA0         | Input  | Synchronous Address Inputs: These pins must be wired to the two LSBs of the address bus for proper burst operation. These inputs are registered and must meet setup and hold times.                                                                                                                                                                                                                                                                                                                                     |
| 5L, 3G<br>(a) (b)                                                                                                                              | SBx              | Input  | Synchronous Byte Write Inputs: "x" refers to the byte being written (byte a, b). SGW overrides SBx.                                                                                                                                                                                                                                                                                                                                                                                                                     |
| 4E                                                                                                                                             | SE1              | Input  | Synchronous Chip Enable: Active low to enable chip.  Negated high — blocks ADSP or deselects chip when ADSC is asserted.                                                                                                                                                                                                                                                                                                                                                                                                |
| 2B                                                                                                                                             | SE2              | Input  | Synchronous Chip Enable: Active high for depth expansion.                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| 6B                                                                                                                                             | SE3              | Input  | Synchronous Chip Enable: Active low for depth expansion.                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| 4H                                                                                                                                             | SGW              | Input  | Synchronous Global Write: This signal writes all bytes regardless of the status of the SBx and SW signals. If only byte write signals SBx are being used, tie this pin high.                                                                                                                                                                                                                                                                                                                                            |
| 4M                                                                                                                                             | SW               | Input  | Synchronous Write: This signal writes only those bytes that have been selected using the byte write \$\overline{SBx}\$ pins. If only byte write signals \$\overline{SBx}\$ are being used, tie this pin low.                                                                                                                                                                                                                                                                                                            |
| 7T                                                                                                                                             | ZZ               | Input  | Sleep Mode: This active high asynchronous signal places the RAM into the lowest power mode. The ZZ pin disables the RAMs internal clock when placed in this mode. When ZZ is negated, the RAM remains in low power mode until it is commanded to READ or WRITE. Data integrity is maintained upon returning to normal operation. NOTE: An internal pull–down is included for compatibility with SRAM devices that do not support sleep mode. A 100% pin compatibility can be achieved if ZZ is left open or pulled low. |
| 4C, 2J, 4J, 6J, 4R                                                                                                                             | V <sub>DD</sub>  | Supply | Core Power Supply.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| 1A, 7A, 1F, 7F, 1J, 7J, 1M, 7M, 1U, 7U                                                                                                         | V <sub>DDQ</sub> | Supply | I/O Power Supply.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| 3D, 5D, 3E, 5E, 3F, 5F, 5G, 3H, 5H, 3K, 5K, 3L, 3M, 5M, 3N, 5N, 3P, 5P                                                                         | V <sub>SS</sub>  | Supply | Ground.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| 1B, 7B, 1C, 7C, 2D, 4D, 7D, 1E, 6E, 2F, 1G, 6G, 2H, 7H, 3J, 5J, 1K, 6K, 2L, 4L, 7L, 6M, 2N, 7N, 1P, 6P, 1R, 5R, 7R, 1T, 4T, 2U, 3U, 4U, 5U, 6U | NC               | _      | No Connection: There is no connection to the chip.                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |

## TRUTH TABLE (See Notes 1 Through 5)

| Next Cycle     | Address<br>Used | SE1 | SE2 | SE3 | ADSP | ADSC | ADV | <b>G</b> 3 | DQx    | Write 2, 4 |
|----------------|-----------------|-----|-----|-----|------|------|-----|------------|--------|------------|
| Deselect       | None            | 1   | Х   | Х   | Х    | 0    | Х   | Х          | High–Z | Х          |
| Deselect       | None            | 0   | Х   | 1   | 0    | Х    | Х   | Х          | High–Z | Х          |
| Deselect       | None            | 0   | 0   | Х   | 0    | Х    | Х   | Х          | High–Z | Х          |
| Deselect       | None            | Х   | Х   | 1   | 1    | 0    | Х   | Х          | High-Z | Х          |
| Deselect       | None            | Х   | 0   | Х   | 1    | 0    | Х   | Х          | High–Z | Х          |
| Begin Read     | External        | 0   | 1   | 0   | 0    | Х    | Х   | Х          | High-Z | Х          |
| Begin Read     | External        | 0   | 1   | 0   | 1    | 0    | Х   | Х          | High-Z | READ       |
| Continue Read  | Next            | Х   | Х   | Х   | 1    | 1    | 0   | 1          | High-Z | READ       |
| Continue Read  | Next            | Х   | Х   | Х   | 1    | 1    | 0   | 0          | DQ     | READ       |
| Continue Read  | Next            | 1   | Х   | Х   | Х    | 1    | 0   | 1          | High-Z | READ       |
| Continue Read  | Next            | 1   | Х   | Х   | Х    | 1    | 0   | 0          | DQ     | READ       |
| Suspend Read   | Current         | Х   | Х   | Х   | 1    | 1    | 1   | 1          | High-Z | READ       |
| Suspend Read   | Current         | Х   | Х   | Х   | 1    | 1    | 1   | 0          | DQ     | READ       |
| Suspend Read   | Current         | 1   | Х   | Х   | Х    | 1    | 1   | 1          | High-Z | READ       |
| Suspend Read   | Current         | 1   | Х   | Х   | Х    | 1    | 1   | 0          | DQ     | READ       |
| Begin Write    | External        | 0   | 1   | 0   | 1    | 0    | Х   | Х          | High-Z | WRITE      |
| Continue Write | Next            | Х   | Х   | Х   | 1    | 1    | 0   | Х          | High-Z | WRITE      |
| Continue Write | Next            | 1   | Х   | Х   | Х    | 1    | 0   | Х          | High-Z | WRITE      |
| Suspend Write  | Current         | Х   | Х   | Х   | 1    | 1    | 1   | Х          | High-Z | WRITE      |
| Suspend Write  | Current         | 1   | Х   | Х   | Х    | 1    | 1   | Х          | High-Z | WRITE      |

#### NOTES:

- 1. X = don't care. 1 = logic high. 0 = logic low.
- 2. Write is defined as either 1) any  $\overline{SBx}$  and  $\overline{SW}$  low or 2)  $\overline{SGW}$  is low.
- 3.  $\overline{G}$  is an asynchronous signal and is not sampled by the clock K.  $\overline{G}$  drives the bus immediately ( $t_{GLQX}$ ) following  $\overline{G}$  going low.
- 4. On write cycles that follow read cycles,  $\overline{G}$  must be negated prior to the start of the write cycle to ensure proper write data setup times.  $\overline{G}$  must also remain negated at the completion of the write cycle to ensure proper write data hold times.

#### **ASYNCHRONOUS TRUTH TABLE**

| Operation  | ZZ | G | I/O Status     |
|------------|----|---|----------------|
| Read       | L  | L | Data Out (DQx) |
| Read       | L  | Н | High–Z         |
| Write      | L  | X | High–Z         |
| Deselected | L  | X | High–Z         |
| Sleep      | Н  | Х | High–Z         |

## LINEAR BURST ADDRESS TABLE ( $\overline{LBO} = V_{SS}$ )

| 1st Address (External) | 2nd Address (Internal) | 3rd Address (Internal) | 4th Address (Internal) |
|------------------------|------------------------|------------------------|------------------------|
| X X00                  | X X01                  | X X10                  | X X11                  |
| X X01                  | X X10                  | X X11                  | X X00                  |
| X X10                  | X X11                  | X X00                  | X X01                  |
| X X11                  | X X00                  | X X01                  | X X10                  |

## **INTERLEAVED BURST ADDRESS TABLE** ( $\overline{LBO} = V_{DD}$ )

| 1st Address (External) | 2nd Address (Internal) | 3rd Address (Internal) | 4th Address (Internal) |
|------------------------|------------------------|------------------------|------------------------|
| X X00                  | X X01                  | X X10                  | X X11                  |
| X X01                  | X X00                  | X X11                  | X X10                  |
| X X10                  | X X11                  | X X00                  | X X01                  |
| X X11                  | X X10                  | X X01                  | X X00                  |

#### **WRITE TRUTH TABLE**

| Cycle Type                | SGW | sw | SBa | SBb | SBc<br>(See Note 1) | SBd<br>(See Note 1) |
|---------------------------|-----|----|-----|-----|---------------------|---------------------|
| Read                      | Н   | Н  | Х   | Х   | Х                   | Х                   |
| Read                      | Н   | L  | Н   | Н   | Н                   | Н                   |
| Write Byte a              | Н   | L  | L   | Н   | Н                   | Н                   |
| Write Byte b              | Н   | L  | Н   | L   | Н                   | Н                   |
| Write Byte c (See Note 1) | Н   | L  | Н   | Н   | L                   | Н                   |
| Write Byte d (See Note 1) | Н   | L  | Н   | Н   | Н                   | L                   |
| Write All Bytes           | Н   | L  | L   | L   | L                   | L                   |
| Write All Bytes           | L   | Х  | Х   | Х   | Х                   | Х                   |

#### NOTE:

1. Valid only for MCM63P737K.

## ABSOLUTE MAXIMUM RATINGS (See Note 1)

| Rating                                                                       | Symbol                             | Value                                              | Unit | Notes |
|------------------------------------------------------------------------------|------------------------------------|----------------------------------------------------|------|-------|
| Power Supply Voltage                                                         | V <sub>DD</sub>                    | V <sub>SS</sub> – 0.5 to 4.6                       | ٧    |       |
| I/O Supply Voltage                                                           | V <sub>DDQ</sub>                   | $V_{SS}$ = 0.5 to $V_{DD}$                         | ٧    |       |
| Input Voltage Relative to V <sub>SS</sub> for Any Pin Except V <sub>DD</sub> | V <sub>in</sub> , V <sub>out</sub> | V <sub>SS</sub> – 0.5 to<br>V <sub>DD</sub> + 0.5  | \ \  |       |
| Input Voltage (Three-State I/O)                                              | V <sub>IT</sub>                    | V <sub>SS</sub> – 0.5 to<br>V <sub>DDQ</sub> + 0.5 | ٧    |       |
| Output Current (per I/O)                                                     | l <sub>out</sub>                   | ±20                                                | mA   |       |
| Package Power Dissipation                                                    | PD                                 | 1.6                                                | W    | 2     |
| Temperature Under Bias                                                       | T <sub>bias</sub>                  | -10 to 85                                          | °C   |       |
| Storage Temperature                                                          | T <sub>stg</sub>                   | -55 to 125                                         | °C   |       |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields; however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high—impedance circuit.

## NOTES:

- Permanent device damage may occur if ABSOLUTE MAXIMUM RATINGS are exceeded. Functional operation should be restricted to RECOMMENDED OPER-ATING CONDITIONS. Exposure to higher than recommended voltages for extended periods of time could affect device reliability.
- Power dissipation capability is dependent upon package characteristics and use environment. See Package Thermal Characteristics.

#### PACKAGE THERMAL CHARACTERISTICS

| Rating                          |                                        | Symbol          | Max      | Unit | Notes |
|---------------------------------|----------------------------------------|-----------------|----------|------|-------|
| TQFP                            |                                        |                 | •        | •    | •     |
| Junction to Ambient (@ 200 lfm) | Single-Layer Board<br>Four-Layer Board | $R_{\theta JA}$ | 40<br>25 | °C/W | 1, 2  |
| Junction to Board (Bottom)      |                                        | $R_{\theta JB}$ | 17       | °C/W | 3     |
| Junction to Case (Top)          |                                        | $R_{	heta JC}$  | 9        | °C/W | 4     |
| PBGA                            |                                        |                 |          |      |       |
| Junction to Ambient (@ 200 lfm) | Single–Layer Board<br>Four–Layer Board | $R_{	heta JA}$  | 38<br>22 | °C/W | 1, 2  |
| Junction to Board (Bottom)      |                                        | $R_{\theta JB}$ | 14       | °C/W | 3     |
| Junction to Case (Top)          |                                        | $R_{	heta JC}$  | 5        | °C/W | 4     |

- 1. Junction temperature is a function of on-chip power dissipation, package thermal resistance, mounting site (board) temperature, ambient temperature, air flow, board population, and board thermal resistance.
- 2. Per SEMI G38-87.
- 3. Indicates the average thermal resistance between the die and the printed circuit board.
- 4. Indicates the average thermal resistance between the die and the case top surface via the cold plate method (MIL SPEC-883 Method 1012.1).

#### DC OPERATING CONDITIONS AND CHARACTERISTICS

 $(V_{DD} = 3.3 \text{ V} + 10\%, -5\%, T_{A} = 0^{\circ} \text{ to } 70^{\circ}\text{C}, \text{ Unless Otherwise Noted})$ 

## **RECOMMENDED OPERATING CONDITIONS AND DC CHARACTERISTICS** (Voltages Referenced to $V_{SS} = 0 \text{ V}$ )

| Parameter                                     | Symbol           | Min   | Тур | Max                                              | Unit |
|-----------------------------------------------|------------------|-------|-----|--------------------------------------------------|------|
| 2.5 V I/O SUPPLY                              | •                |       | •   | •                                                | •    |
| Supply Voltage                                | V <sub>DD</sub>  | 3.135 | 3.3 | 3.465                                            | V    |
| I/O Supply Voltage                            | V <sub>DDQ</sub> | 2.375 | 2.5 | 2.9                                              | ٧    |
| Input Low Voltage                             | V <sub>IL</sub>  | -0.3* | _   | 0.7                                              | ٧    |
| Input High Voltage                            | V <sub>IH</sub>  | 1.7   | _   | V <sub>DD</sub> + 0.3**                          | ٧    |
| Input High Voltage I/O Pins                   | V <sub>IH2</sub> | 1.7   | _   | V <sub>DDQ</sub> + 0.3**                         | ٧    |
| Output Low Voltage (I <sub>OL</sub> = 2 mA)   | V <sub>OL</sub>  | _     | _   | 0.7                                              | ٧    |
| Output High Voltage (I <sub>OH</sub> = -2 mA) | Voн              | 1.7   | _   | _                                                | ٧    |
| 3.3 V I/O SUPPLY                              |                  | •     | •   |                                                  |      |
| Supply Voltage                                | V <sub>DD</sub>  | 3.135 | 3.3 | 3.465                                            | ٧    |
| I/O Supply Voltage                            | V <sub>DDQ</sub> | 3.135 | 3.3 | V <sub>DD</sub>                                  | ٧    |
| Input Low Voltage                             | V <sub>IL</sub>  | -0.5* | _   | 0.8                                              | ٧    |
| Input High Voltage                            | VIH              | 2     | _   | V <sub>DD</sub> + 0.5***                         | ٧    |
| Input High Voltage I/O Pins                   | V <sub>IH2</sub> | 2     | _   | V <sub>DDQ</sub> + 0.5***                        | ٧    |
| Output Low Voltage (I <sub>OL</sub> = 8 mA)   | V <sub>OL</sub>  | _     | _   | 0.4                                              | ٧    |
| Output High Voltage (I <sub>OH</sub> = -4 mA) | V <sub>OH</sub>  | 2.4   | _   | <del>                                     </del> | V    |

<sup>\*</sup> Undershoot:  $V_{IL} > -1.0 \text{ V}$  for t < 20% t<sub>KHKH</sub>.

#### **SUPPLY CURRENTS**

| Parameter                                                                                                                                                                                                                                                  |                  | Symbol              | Min | Тур | Max                           | Unit | Notes   |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------|---------------------|-----|-----|-------------------------------|------|---------|
| Input Leakage Current (0 V ≤ V <sub>in</sub> ≤ V <sub>DD</sub> )                                                                                                                                                                                           |                  | l <sub>lkg(l)</sub> | _   | _   | ±1                            | μА   | 1       |
| Output Leakage Current (0 V ≤ V <sub>in</sub> ≤ V <sub>D</sub> [                                                                                                                                                                                           | )Q)              | llkg(O)             | _   | _   | ±1                            | μА   |         |
| AC Supply Current (Device Selected, All Outputs Open, Freq = Max)         MCM63P737K/819K-166           Includes VDD Only         MCM63P737K/819K-133                                                                                                      |                  | <sup>I</sup> DDA    | _   | _   | 500/430<br>470/400<br>450/380 | mA   | 2, 3, 4 |
| CMOS Standby Supply Current (Device IVDD = Max, All Inputs Static at CMOS Le                                                                                                                                                                               | I <sub>SB2</sub> | _                   | _   | 30  | mA                            | 5, 6 |         |
| Sleep Mode Supply Current (Device Deselected, Freq = Max, $V_{DD}$ = Max, All Other Inputs Static at CMOS Levels, $ZZ \ge V_{DD} - 0.2 \text{ V}$ )                                                                                                        |                  | lzz                 | _   | _   | 15                            | mA   | 1, 5, 6 |
| TTL Standby Supply Current (Device Deselected, Freq = 0, VDD = Max, All Inputs Static at TTL Levels)                                                                                                                                                       |                  | I <sub>SB3</sub>    | _   | _   | 35                            | mA   | 5, 7    |
| Clock Running (Device Deselected, Freq = Max, V <sub>DD</sub> = Max, All Inputs MCM63P737K/819K-150 MCM63P737K/819K-133                                                                                                                                    |                  | I <sub>SB4</sub>    | _   | _   | 185/170<br>175/160<br>160/145 | mA   | 5, 6    |
| Static Clock Running         MCM63P737K/819K-166           (Device Deselected,         MCM63P737K/819K-150           Freq = Max, V <sub>DD</sub> = Max, All Inputs         MCM63P737K/819K-133           Static at TTL Levels)         MCM63P737K/819K-133 |                  | I <sub>SB5</sub>    |     | _   | 75/65<br>70/60<br>65/55       | mA   | 5, 7    |

- 1. LBO and ZZ pins have an internal pull-up and pull-down, respectively; and will exhibit leakage currents of ±5 µA.
- 2. Reference AC Operating Conditions and Characteristics for input and timing.
- 3. All addresses transition simultaneously low (LSB) then high (MSB).
- 4. Data states are all zero.
- 5. Device is deselected as defined by the Truth Table.
- 6. CMOS levels for I/Os are  $V_{IT} \le V_{SS} + 0.2 \text{ V}$  or  $\ge V_{DDQ} 0.2 \text{ V}$ . CMOS levels for other inputs are  $V_{in} \le V_{SS} + 0.2 \text{ V}$  or  $\ge V_{DD} 0.2 \text{ V}$ .
- 7. TTL levels for I/Os are  $V_{IT} \le V_{IL}$  or  $\ge V_{IH2}$ . TTL levels for other inputs are  $V_{in} \le V_{IL}$  or  $\ge V_{IH1}$ .

<sup>\*\*</sup> Overshoot:  $V_{IH}/V_{IH2} < V_{DD}/V_{DDQ} + 1.0 V$  (not to exceed 3.6 V) for t < 20% t<sub>KHKH</sub>.

<sup>\*\*\*</sup> Overshoot: VIH/VIH2 < VDD/VDDQ + 1.0 V (not to exceed 4.6 V) for t < 20% tKHKH.

## CAPACITANCE (f = 1.0 MHz, T<sub>A</sub> = 0 to 70°C, Periodically Sampled Rather Than 100% Tested)

| Parameter                |                  | Min | Тур | Max | Unit |
|--------------------------|------------------|-----|-----|-----|------|
| Input Capacitance        | C <sub>in</sub>  | _   | 4   | 5   | pF   |
| Input/Output Capacitance | C <sub>I/O</sub> | _   | 7   | 8   | pF   |

#### **AC OPERATING CONDITIONS AND CHARACTERISTICS**

 $(V_{DD} = 3.3 \text{ V} + 10\%, -5\%, T_{A} = 0 \text{ to } 70^{\circ}\text{C}, \text{ Unless Otherwise Noted})$ 

| Input Timing Measurement Reference Level 1.5 | V Output T                   | iming Reference Level |                 | 1.5 V           |
|----------------------------------------------|------------------------------|-----------------------|-----------------|-----------------|
| Input Pulse Levels                           | <ul> <li>Output L</li> </ul> | oad See               | Figure 2 Unless | Otherwise Noted |
| Input Rise/Fall Time 1.0 V/ns (20% to 80%    | ·)                           |                       |                 |                 |

#### READ/WRITE CYCLE TIMING (See Notes 1 and 2)

|                                                                 |                                             | MCM63P8 |     | MCM63P8 |     | MCM63P3 |     |      |       |
|-----------------------------------------------------------------|---------------------------------------------|---------|-----|---------|-----|---------|-----|------|-------|
| Parameter                                                       | Symbol                                      | Min     | Max | Min     | Max | Min     | Max | Unit | Notes |
| Cycle Time                                                      | <sup>t</sup> KHKH                           | 6       | _   | 6.7     | _   | 7.5     | _   | ns   |       |
| Clock High Pulse Width                                          | <sup>t</sup> KHKL                           | 2.4     | _   | 2.6     | _   | 3       | _   | ns   | 3     |
| Clock Low Pulse Width                                           | <sup>†</sup> KLKH                           | 2.4     | _   | 2.6     | _   | 3       | _   | ns   | 3     |
| Clock Access Time                                               | <sup>t</sup> KHQV                           | _       | 3.5 | _       | 3.8 | _       | 4   | ns   |       |
| Output Enable to Output Valid                                   | <sup>t</sup> GLQV                           | _       | 3.5 | _       | 3.5 | _       | 3.8 | ns   |       |
| Clock High to Output Active                                     | <sup>t</sup> KHQX1                          | 0       | _   | 0       | _   | 0       | _   | ns   | 4, 5  |
| Clock High to Output Change                                     | <sup>t</sup> KHQX2                          | 1.5     | _   | 1.5     | _   | 1.5     | _   | ns   | 4     |
| Output Enable to Output Active                                  | <sup>t</sup> GLQX                           | 0       | _   | 0       | _   | 0       | _   | ns   | 4, 5  |
| Output Disable to Q High-Z                                      | <sup>t</sup> GHQZ                           | _       | 3.5 | _       | 3.5 | _       | 3.8 | ns   | 4, 5  |
| Clock High to Q High-Z                                          | <sup>t</sup> KHQZ                           | 1.5     | 3.5 | 1.5     | 3.5 | 1.5     | 3.5 | ns   | 4, 5  |
| Setup Times:  Address ADSP, ADSC, ADV Data In Write Chip Enable | tADKH tADSKH tDVKH tWVKH tEVKH              | 1.5     | ı   | 1.5     | _   | 1.5     |     | ns   |       |
| Hold Times:  Address ADSP, ADSC, ADV Data In Write Chip Enable  | tKHAX<br>tKHADSX<br>tKHDX<br>tKHWX<br>tKHEX | 0.5     | 1   | 0.5     | _   | 0.5     |     | ns   |       |

- 1. Write is defined as either any SBx and SW low or SGW is low. Chip Enable is defined as SE1 low, SE2 high, and SE3 low whenever ADSP or ADSC is asserted.
- 2. All read and write cycle timings are referenced from K or  $\overline{\textbf{G}}.$
- 3. In order to reduce test correlation issues and to reduce the effects of application specific input edge rate variations on correlation between data sheet parameters and actual system performance, FSRAM AC parametric specifications are always specified at VDDQ/2. In some design exercises, it is desirable to evaluate timing using other reference levels. Since the maximum test input edge rate is known and is given in the AC Test Conditions section of the data sheet as 1 V/ns, one can easily interpolate timing values to other reference levels.
- 4. This parameter is sampled and not 100% tested.
- 5. Measured at ±200 mV from steady state.

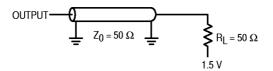


Figure 1. AC Test Load

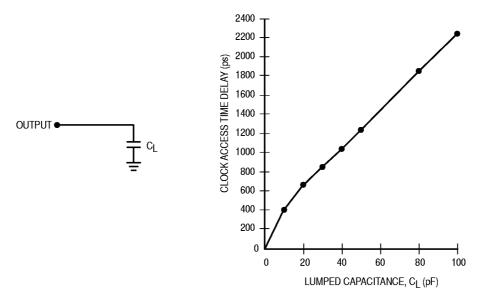
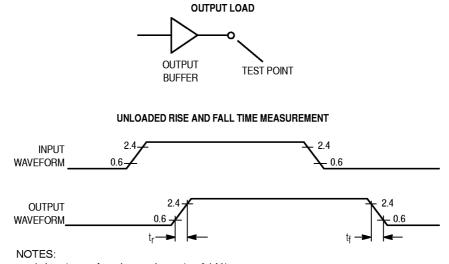
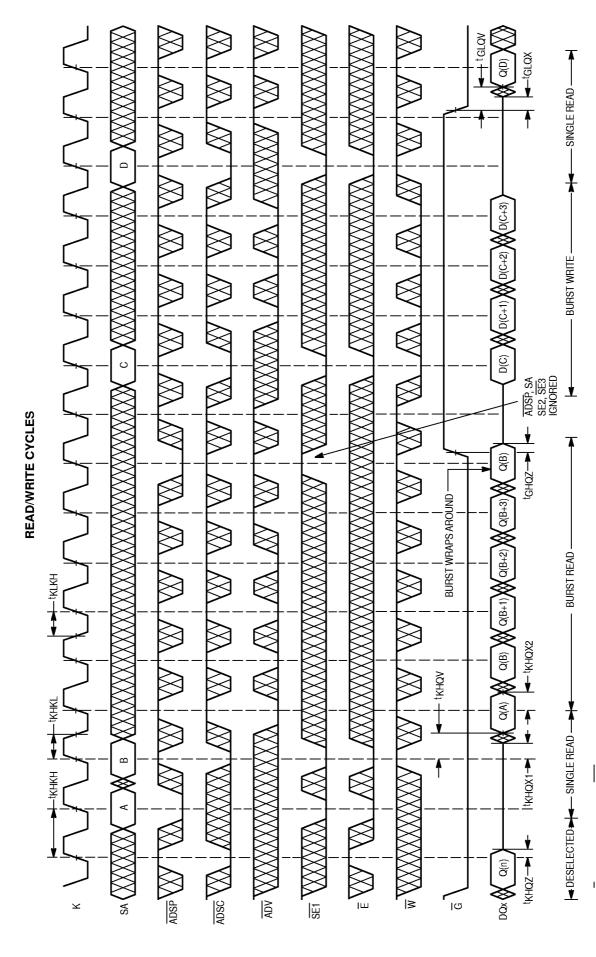


Figure 2. Lumped Capacitive Load and Typical Derating Curve

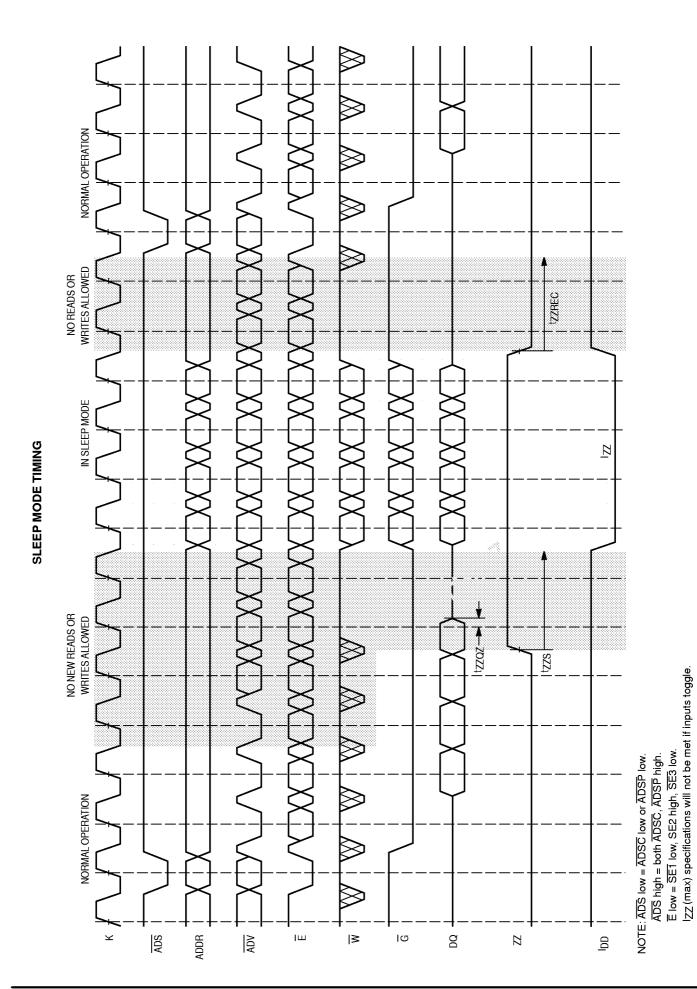


- 1. Input waveform has a slew rate of 1 V/ns.
- 2. Rise time is measured from 0.6 to 2.4 V unloaded.
- 3. Fall time is measured from 2.4 to 0.6 V unloaded.

Figure 3. Unloaded Rise and Fall Time Characterization



NOTE:  $\overline{E}$  low = SE2 high and  $\overline{SE3}$  low.  $\overline{\overline{W}}$  low =  $\overline{SGW}$  low and/or  $\overline{SW}$  and  $\overline{SBx}$  low.



#### APPLICATION INFORMATION

#### **SLEEP MODE**

A sleep mode feature, the ZZ pin, has been implemented on the MCM63P737K and MCM63P819K. It allows the system designer to place the RAM in the lowest possible power condition by asserting ZZ. The Sleep Mode Timing diagram shows the different modes of operation: Normal Operation, No READ/WRITE Allowed, and Sleep Mode. Each mode has its own set of constraints and conditions that are allowed.

Normal Operation: All inputs must meet setup and hold times prior to sleep and tZZREC nanoseconds after recovering from sleep. Clock (K) must also meet cycle, high, and low times during these periods. Two cycles prior to sleep, initiation of either a read or write operation is not allowed.

No READ/WRITE: During the period of time just prior to sleep and during recovery from sleep, the assertion of either ADSC, ADSP, or any write signal is not allowed. If a write operation occurs during these periods, the memory array may be corrupted. Validity of data out from the RAM can not be guaranteed immediately after ZZ is asserted (prior to being in sleep).

Sleep Mode: The RAM automatically deselects itself. The RAM disconnects its internal clock buffer. The external clock

may continue to run without impacting the RAMs sleep current ( $I_{ZZ}$ ). All inputs are allowed to toggle — the RAM will not be selected and perform any reads or writes. However, if inputs toggle, the  $I_{ZZ}$  (max) specification will not be met.

Note: It is invalid to go from stop clock mode directly into sleep mode.

#### NON-BURST SYNCHRONOUS OPERATION

Although this BurstRAM has been designed for high end MPU-based systems, these SRAMs can be used in other high speed memory applications that do not require the burst address feature. Most L2 caches designed with a synchronous interface can make use of the MCM63P737K and MCM63P819K. The burst counter feature of the BurstRAMs can be disabled, and the SRAMs can be configured to act upon a continuous stream of addresses. See Figure 5.

CONTROL PIN TIE VALUES EXAMPLE ( $H \ge V_{IH}, L \le V_{IL}$ )

| Non-Burst                         | ADSP | ADSC | ADV | SE1 | SE2 | LBO |
|-----------------------------------|------|------|-----|-----|-----|-----|
| Sync Non–Burst,<br>Pipelined SRAM | Н    | L    | I   | ٦   | I   | X   |

NOTE: Although X is specified in the table as a don't care, the pin must be tied either high or low.

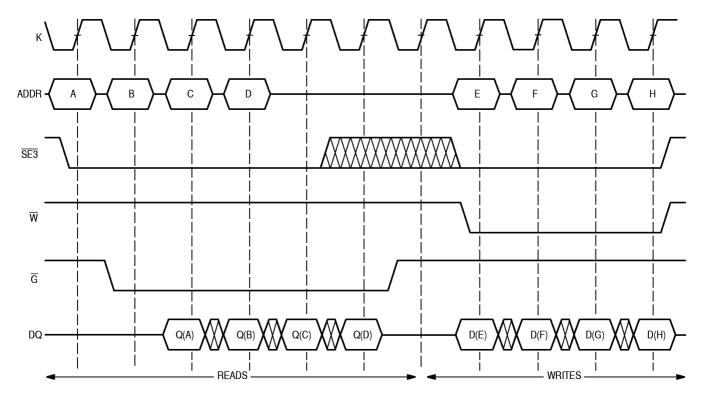
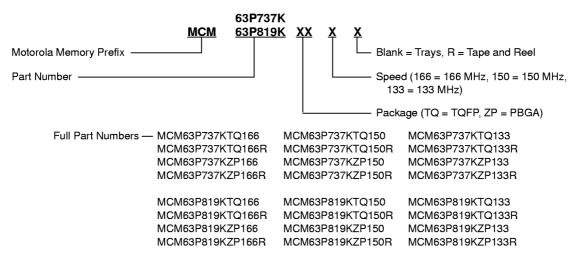


Figure 4. Example Configuration as Non-Burst Synchronous SRAM

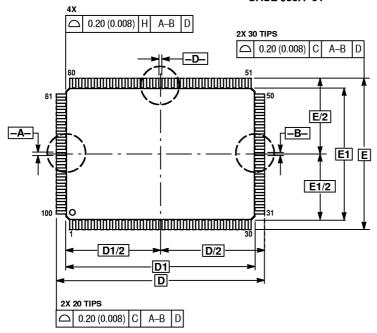
## ORDERING INFORMATION

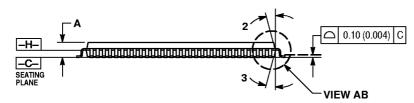
(Order by Full Part Number)

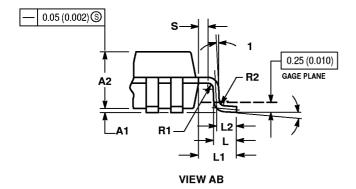


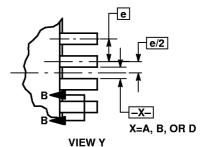
## **PACKAGE DIMENSIONS**

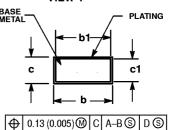
#### **TQ PACKAGE TQFP** CASE 983A-01











#### SECTION B-B

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- Y14.5M, 1982.

  2. CONTROLLING DIMENSION: MILLIMETER.

  3. DATUM PLANE -H- IS LOCATED AT BOTTOM OF LEAD AND IS COINCIDENT WITH THE LEAD WHERE THE LEAD EXITS THE PLASTIC BODY AT THE BOTTOM OF THE PARTING LINE.

  4. DATUMS -A-, -B- AND -D- TO BE DETERMINED AT DATUM PLANE -H-.

  5. DIMENSIONS D. AND E TO BE DETERMINED AT

- AT DATUM PLANE -H-.

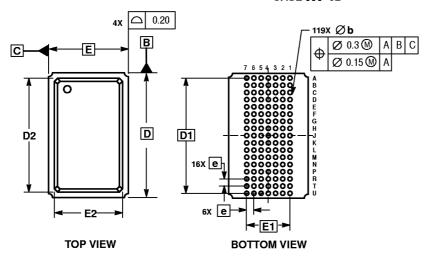
  5. DIMENSIONS D AND E TO BE DETERMINED AT
  SEATING PLANE -C-.

  6. DIMENSIONS DI AND E1 DO NOT INCLUDE MOLD
  PROTRUSION. ALLOWABLE PROTRUSION IS 0.25
  (0.010) PER SIDE. DIMENSIONS DI AND B1 DO
  INCLUDE MOLD MISMATCH AND ARE
- DETERMINED AT DATUM PLANE -H-.

  7. DIMENSION 6 DOES NOT INCLUDE DAMBAR PROTRUSION. DAMBAR PROTRUSION SHALL NOT CAUSE THE 6 DIMENSION TO EXCEED 0.45

|     | MILLIMETERS |      | INCHES    |       |  |
|-----|-------------|------|-----------|-------|--|
| DIM | MIN         | MAX  | MIN       | MAX   |  |
| Α   |             | 1.60 |           | 0.063 |  |
| A1  | 0.05        | 0.15 | 0.002     | 0.006 |  |
| A2  | 1.35        | 1.45 | 0.053     | 0.057 |  |
| b   | 0.22        | 0.38 | 0.009     | 0.015 |  |
| b1  | 0.22        | 0.33 | 0.009     | 0.013 |  |
| С   | 0.09        | 0.20 | 0.004     | 0.008 |  |
| c1  | 0.09        | 0.16 | 0.004     | 0.006 |  |
| D   | 22.00       | BSC  | 0.866     | BSC   |  |
| D1  | 20.00       | BSC  | 0.787 BSC |       |  |
| E   | 16.00       | BSC  | 0.630 BSC |       |  |
| E1  | 14.00       | BSC  | 0.551     | BSC   |  |
| е   | 0.65        | BSC  | 0.026 BSC |       |  |
| L   | 0.45        | 0.75 | 0.018     | 0.030 |  |
| L1  | 1.00        | REF  | 0.039 REF |       |  |
| L2  | 0.50        | REF  | 0.020 REF |       |  |
| S   | 0.20        |      | 0.008     |       |  |
| R1  | 0.08        |      | 0.003     |       |  |
| R2  | 0.08        | 0.20 | 0.003     | 0.008 |  |
|     | 0           | 7    | 0         | 7     |  |
| _1  | 0           | _    | 0         | _     |  |
| 2   | 11          | 13   | 11        | 13    |  |
| 3   | 11          | 13   | 11        | 13    |  |

#### **ZP PACKAGE** 7 x 17 BUMP PBGA CASE 999-02





- NOTES:

  1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

  2. ALL DIMENSIONS IN MILLIMETERS.

  3. DIMENSION IS THE MAXIMUM SOLDER BALL DIAMETER MEASURED PARALLEL TO DATUM A.

  4. DATUM A, THE SEATING PLANE, IS DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.

|     | MILLIMETERS |       |  |  |  |  |
|-----|-------------|-------|--|--|--|--|
| DIM | MIN         | MAX   |  |  |  |  |
| Α   | _           | 2.40  |  |  |  |  |
| A1  | 0.50        | 0.70  |  |  |  |  |
| A2  | 1.30        | 1.70  |  |  |  |  |
| A3  | 0.80        | 1.00  |  |  |  |  |
| D   | 22.00 BSC   |       |  |  |  |  |
| D1  | 20.32       | BSC   |  |  |  |  |
| D2  | 19.40       | 19.60 |  |  |  |  |
| Е   | 14.00       | BSC   |  |  |  |  |
| E1  | 7.62        | BSC   |  |  |  |  |
| E2  | 11.90       | 12.10 |  |  |  |  |
| b   | 0.60        | 0.90  |  |  |  |  |
| е   | 1.27 BSC    |       |  |  |  |  |

